

## N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ☒ Spilt Gate Trench Technology
- ☒ Excellent  $R_{DS(ON)}$
- ☒ Low gate charge

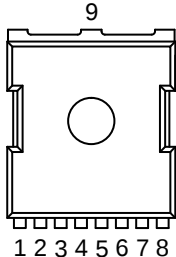
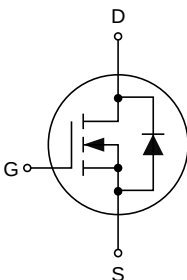
#### 1.2 Applications

- ☒ Load Switch for Portable Device
- ☒ DC/DC Converter
- ☒ Battery Switch

#### 1.3 Quick reference

- ☒  $BV \geq 100V$
- ☒  $P_{tot} \leq 192W$
- ☒  $I_D \leq 120A$
- ☒  $R_{DS(ON)} \leq 5.4m\Omega @ V_{GS} = 10V$

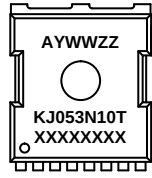
### 2. Pin Description

| Pin           | Description | Simplified Outline                                                                                               | Symbol                                                                                |
|---------------|-------------|------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| 1             | Gate(G)     |  <p>Top View<br/>TOLL-8L</p> |  |
| 2,3,4,5,6,7,8 | Source(S)   |                                                                                                                  |                                                                                       |
| 9             | Drain(D)    |                                                                                                                  |                                                                                       |

## 3. Limiting Values

| Symbol          | Parameter                           | Conditions                     | Min | Max      | Unit          |
|-----------------|-------------------------------------|--------------------------------|-----|----------|---------------|
| $V_{DS}$        | Drain-Source Voltage                | $T_C=25^{\circ}C$              | 100 | -        | V             |
| $V_{GS}$        | Gate-Source Voltage                 | $T_C=25^{\circ}C$              | -   | $\pm 20$ | V             |
| $I_D$           | Drain Current (DC)                  | $T_C=25^{\circ}C, V_{GS}=10V$  | -   | 120      | A             |
|                 |                                     | $T_C=100^{\circ}C, V_{GS}=10V$ | -   | 84       | A             |
| $I_{DM}^1$      | Drain Current (Pulsed)              | $T_C=25^{\circ}C, V_{GS}=10V$  | -   | 440      | A             |
| $P_{tot}$       | Drain power dissipation             | $T_C=25^{\circ}C$              | -   | 192      | W             |
| $T_{stg}$       | Storage Temperature                 |                                | -55 | 150      | $^{\circ}C$   |
| $T_J$           | Junction Temperature                |                                | -   | 150      | $^{\circ}C$   |
| $I_S$           | Continuous-Source Current           | $T_C=25^{\circ}C$              | -   | 120      | A             |
| $E_{AS}^2$      | Single Pulsed Avalanche Energy      |                                | -   | 225      | mJ            |
| $R_{\theta JC}$ | Thermal Resistance-Junction to Case |                                | -   | 0.65     | $^{\circ}C/W$ |

## 4. Marking Information

| Product Name | Marking                                                                               |
|--------------|---------------------------------------------------------------------------------------|
| KJ053N10T    |  |

## 5. Ordering Code

| Product Name | Package | Reel Size | Tape width | Quantity | Note |
|--------------|---------|-----------|------------|----------|------|
| KJ053N10T    | TOLL-8L | -         | -          | 2000     |      |

Note: KUAJIEXIN defines "Green" as lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC/JEDEC J-STD-020C)

## 6. Electrical Characteristics (T<sub>A</sub>=25°C Unless Otherwise Noted)

| Symbol                             | Parameter                                     | Conditions                                                                             | Min | Typ  | Max  | Unit |
|------------------------------------|-----------------------------------------------|----------------------------------------------------------------------------------------|-----|------|------|------|
| Static Characteristics             |                                               |                                                                                        |     |      |      |      |
| BV <sub>DSS</sub>                  | Drain-Source Breakdown Voltage                | V <sub>GS</sub> =0V, I <sub>DS</sub> =250μA                                            | 100 | -    | -    | V    |
| V <sub>GS(th)</sub>                | Gate Threshold Voltage <sup>3</sup>           | V <sub>DS</sub> =V <sub>GS</sub> , I <sub>DS</sub> =250μA                              | 2   | 3    | 4    | V    |
| I <sub>DSS</sub>                   | Zero Gate Voltage Source Current              | V <sub>DS</sub> =100V, V <sub>GS</sub> =0V                                             | -   | -    | 1    | μA   |
| I <sub>GSS</sub>                   | Gate-Body Leakage Current                     | V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V                                             | -   | -    | ±100 | nA   |
| R <sub>DS(ON)</sub>                | Drain-Source On-State Resistance <sup>3</sup> | V <sub>GS</sub> =10V, I <sub>DS</sub> =20A                                             | -   | 4.5  | 5.4  | mΩ   |
| R <sub>G</sub>                     | Gate Resistance                               | Frequency=1.0MHz                                                                       | -   | 3.5  | -    | Ω    |
| Dynamic Characteristics            |                                               |                                                                                        |     |      |      |      |
| C <sub>iss</sub>                   | Input Capacitance                             | V <sub>GS</sub> =0V, V <sub>DS</sub> =50V<br>Frequency=1MHz                            | -   | 3244 | -    | pF   |
| C <sub>oss</sub>                   | Output Capacitance                            |                                                                                        | -   | 1075 | -    |      |
| C <sub>rss</sub>                   | Reverse Transfer Capacitance                  |                                                                                        | -   | 52   | -    |      |
| Switching Characteristics          |                                               |                                                                                        |     |      |      |      |
| t <sub>d(on)</sub>                 | Turn-on Delay Time                            | V <sub>DS</sub> =50V, R <sub>L</sub> =2.5Ω<br>V <sub>GS</sub> =10V, R <sub>G</sub> =6Ω | -   | 22   | -    | ns   |
| t <sub>r</sub>                     | Turn-on Rise Time                             |                                                                                        | -   | 36   | -    |      |
| t <sub>d(off)</sub>                | Turn-off Delay Time                           |                                                                                        | -   | 49   | -    |      |
| t <sub>f</sub>                     | Turn-off Fall Time                            |                                                                                        | -   | 31   | -    |      |
| Q <sub>g</sub>                     | Total Gate Charge                             | V <sub>DS</sub> =50V, I <sub>DS</sub> =20A<br>V <sub>GS</sub> =10V                     | -   | 51   | -    | nC   |
| Q <sub>gs</sub>                    | Gate-Source Charge                            |                                                                                        | -   | 15   | -    |      |
| Q <sub>gd</sub>                    | Gate-Drain Charge                             |                                                                                        | -   | 13   | -    |      |
| Source-Drain Diode Characteristics |                                               |                                                                                        |     |      |      |      |
| V <sub>DS</sub>                    | Diode Forward Voltage <sup>3</sup>            | V <sub>GS</sub> =0V, I <sub>DS</sub> =20A                                              | -   | -    | 1.2  | V    |
| I <sub>S</sub>                     | Diode Forward Current <sup>4</sup>            |                                                                                        | -   | -    | 120  | A    |
| t <sub>rr</sub>                    | Reverse Recovery Time                         | I <sub>DS</sub> =15A, V <sub>GS</sub> =0V<br>dlf/dt=100A/μs                            | -   | 58   | -    | ns   |
| Q <sub>rr</sub>                    | Reverse Recovery Charge                       |                                                                                        | -   | 90   | -    | nC   |

Notes:

1. Repetitive Rating: pulse width limited by maximum junction temperature
2. E<sub>AS</sub> condition: T<sub>J</sub>=25°C, V<sub>DD</sub>=50V, R<sub>G</sub>=25Ω, L=0.5mH
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%
4. Surface Mounted on FR-4 Board, t ≤ 10 sec

## 7. Typical Characteristics

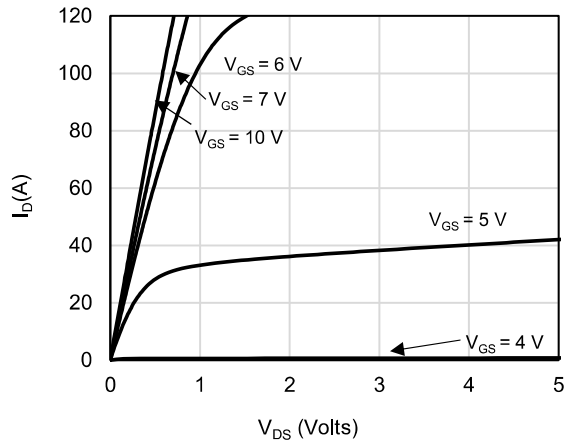


Figure 1: On-Region Characteristics

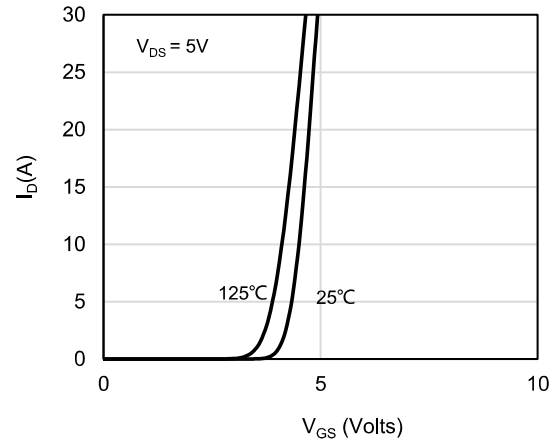


Figure 2: Transfer Characteristics

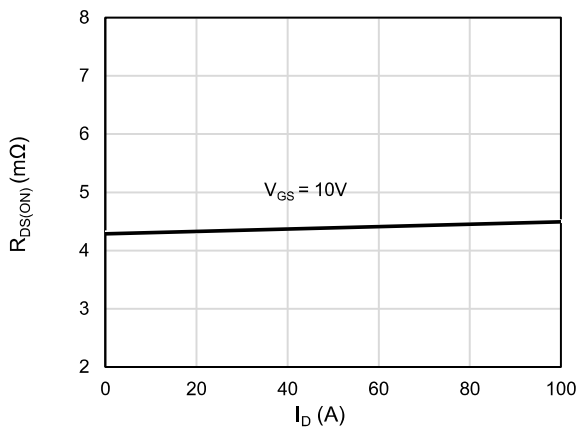


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

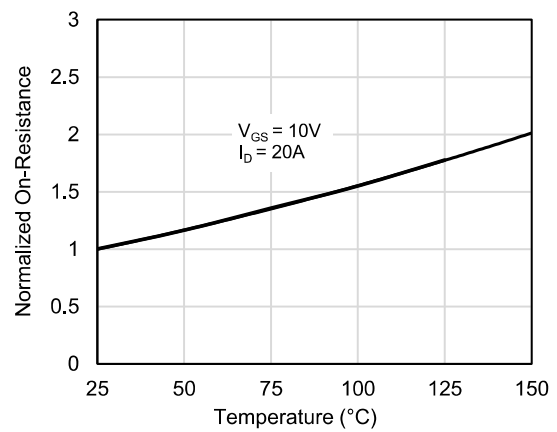


Figure 4: On-Resistance vs. Junction Temperature

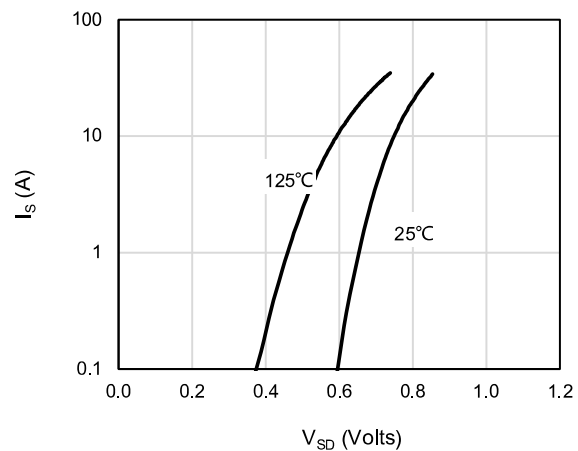


Figure 5: Body-Diode Characteristics

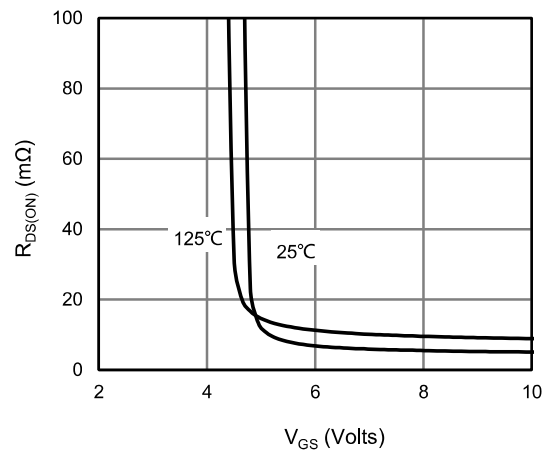


Figure 6: On-Resistance vs. Gate-Source Voltage

## 7. Typical Characteristics (Cont.)

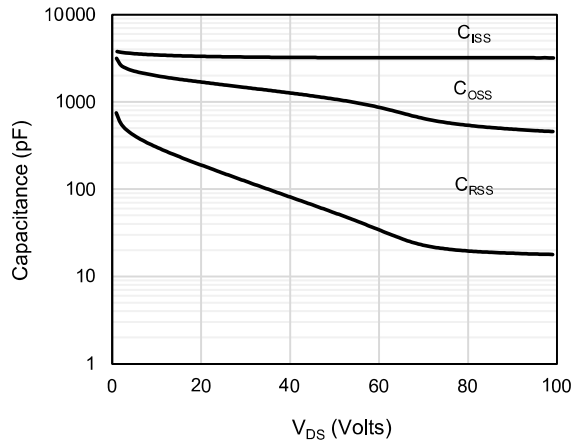


Figure 7: Capacitance Characteristics

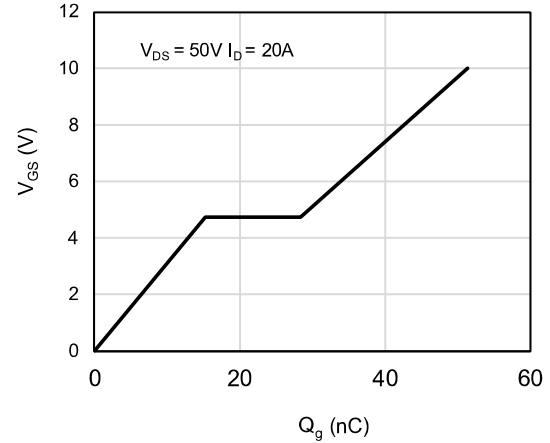


Figure 8: Gate-Charge Characteristics

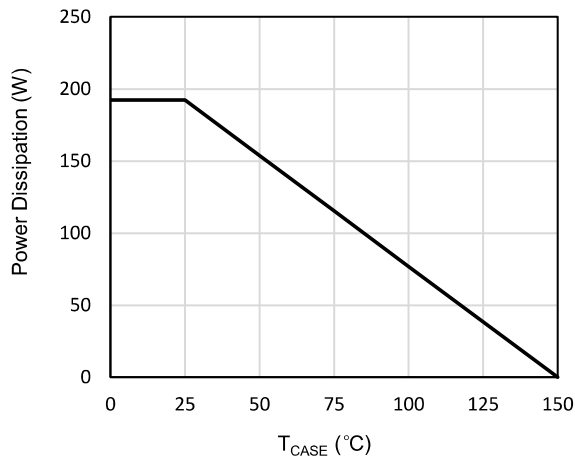


Figure 9: Power De-rating

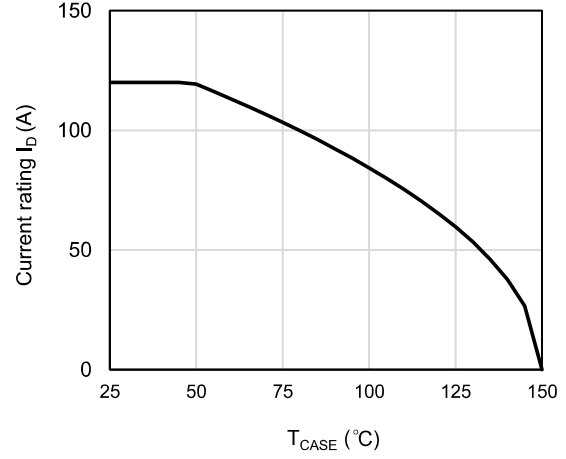


Figure 10: Current De-rating

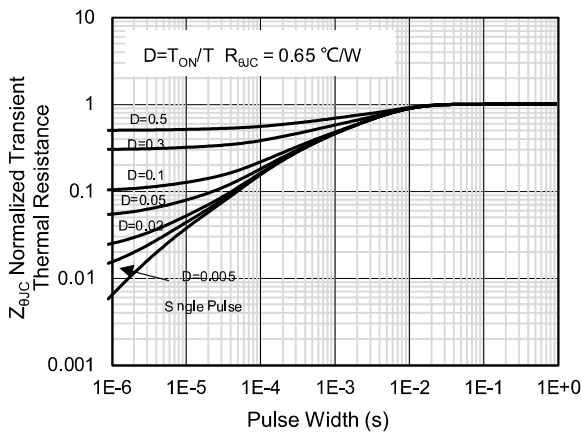


Figure 11: Normalized Maximum Transient Thermal Impedance

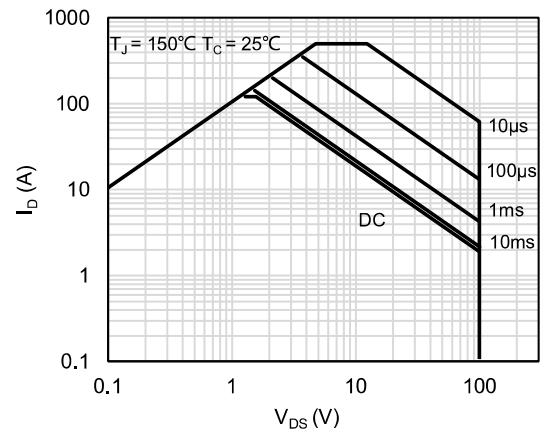
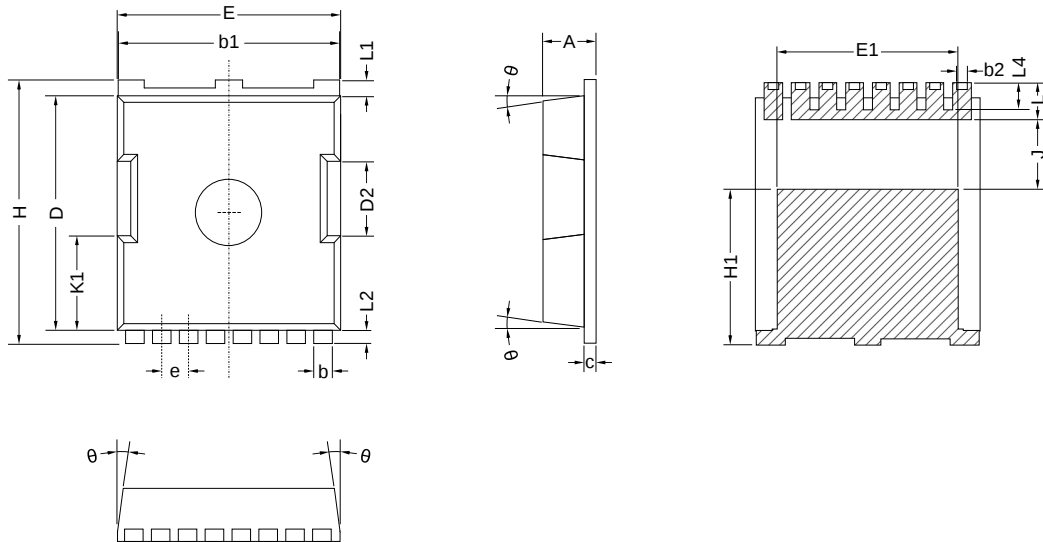


Figure 12: Maximum Forward Biased Safe Operating Area

## 8. Package Dimensions

### TOLL-8L Package



| Symbol | Dimensions In Millimeters |       |
|--------|---------------------------|-------|
|        | MIN.                      | MAX.  |
| A      | 2.20                      | 2.40  |
| b      | 0.70                      | 0.90  |
| b1     | 9.70                      | 9.90  |
| b2     | 0.42                      | 0.50  |
| c      | 0.40                      | 0.60  |
| D      | 10.28                     | 10.58 |
| D2     | 3.10                      | 3.50  |
| E      | 9.70                      | 10.10 |
| E1     | 7.90                      | 8.30  |
| e      | 1.20BSC                   |       |
| H      | 11.48                     | 11.88 |
| H1     | 6.75                      | 7.15  |
| N      | 8.00                      |       |
| J      | 3.00                      | 3.30  |
| K1     | 3.98                      | 4.38  |
| L      | 1.40                      | 1.80  |
| L1     | 0.60                      | 0.80  |
| L2     | 0.50                      | 0.70  |
| L4     | 1.00                      | 1.30  |
| θ      | 4°                        | 10°   |